



IFW

TRANSMITTAL OF FORMAL DRAWINGS

Docket No.
YOR920030526US1 (17107)

In the Application Of: **Stephen W. Bedell, et al.**

Application No.	Filing Date	Confirmation No.	Examiner	Customer No.	Group Art Unit
10/728,519	12/5/2003	Unassigned	Unassigned	23389	2818

Invention: **METHOD OF FABRICATING STRAINED Si SOI WAFERS**

Address to:
**Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450**

Transmitted herewith are:

4 sheets of formal drawing(s) for this application.

☒ Each sheet of drawing indicates the identifying indicia suggested in 37 CFR Section 1.84(c).

Signature

**Leslie S. Szivos, Ph.D.
Registration No. 39,394**

Dated: **July 26, 2004**

I certify that this document and attached formal drawings are being deposited on **7/26/2004** with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Signature of Person Mailing Correspondence

Leslie S. Szivos, Ph.D.

Typed or Printed Name of Person Mailing Correspondence